#### DESCRIPTION

The SPN1026 is the Dual N-Channel enhancement mode field effect transistors are produced using high cell density DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 320mA DC and can deliver pulsed currents up to 1.0A. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

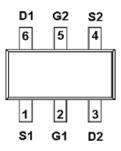
#### APPLICATIONS

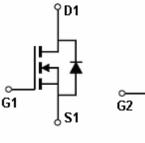
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

#### FEATURES

- 60V/0.50A, RDS(ON)=  $5.0\Omega@VGS=10V$
- 60V/0.30A, RDS(ON)=  $5.5\Omega@VGS=5V$
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- SOT-563 / SC-89-6L package design

#### PIN CONFIGURATION( SOT-563 / SC-89-6L )





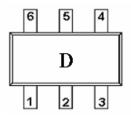
n-channel

n-channel

D2

S2

#### PART MARKING





PIN DESCRIPTION						
Pin	Symbol	Description				
1	S1	Source 1				
2	G1	Gate 1				
3	D2	Drain 2				
4	S2	Source 2				
5	G2	Gate 2				
6	D1	Drain1				

#### **ORDERING INFORMATION**

Part Number	Package	Part Marking
SPN1026S56RG	SOT-563	D
SPN1026S56RGB	SOT-563	D

\* SPN1026S56RG : Tape Reel ; Pb – Free

X SPN1026S56RGB : Tape Reel ; Pb – Free, Halogen – Free

#### **ABSOULTE MAXIMUM RATINGS** (TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage		VDSS	60	V
Gate –Source Voltage - Continuous	VGSS	±20	V	
Gate –Source Voltage - Non Repetitive ( tp	VGSS	±40	V	
Continuous Drain Current(TJ=150°C)	TA=25°C	ID	0.32	А
Pulsed Drain Current (*)	Ідм	1.0	А	
Continuous Source Current(Diode Conduction)		Is	0.25	А
Power Dissipation	TA=25°C	PD	0.30	W
Operating Junction Temperature	Тл	-55 ~ 150	°C	
Storage Temperature Range		Tstg	-55 ~ 150	°C
Thermal Resistance-Junction to Ambient		Rөја	375	°C/W



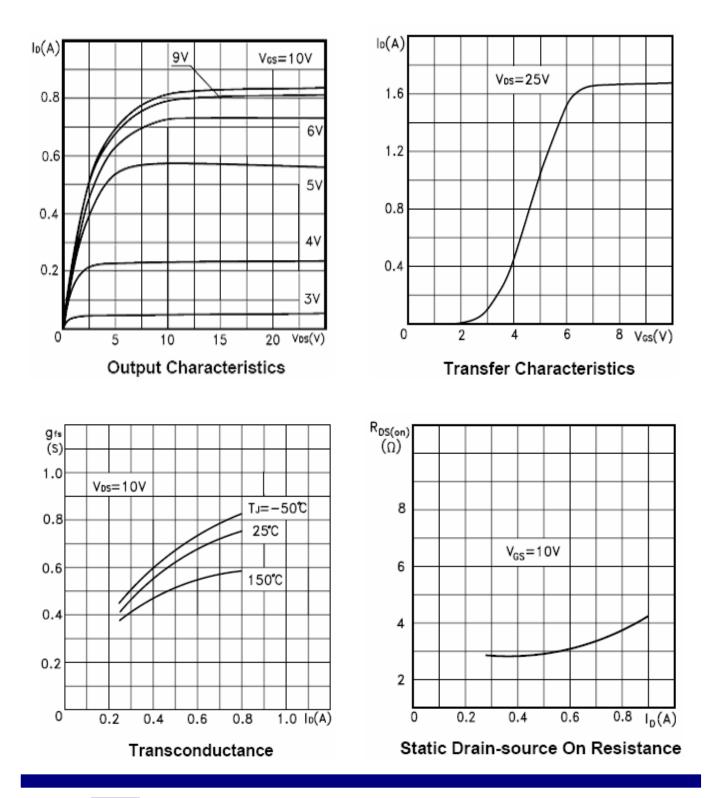
### (\*) Pulse width limited by safe operating area **ELECTRICAL CHARACTERISTICS** (TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static					1		
Drain-Source Breakdown Voltage	V(BR)DSS	Vgs=0V,Id=250uA	60			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1.0	1.7	2.5	v	
Gate Leakage Current	IGSS	VDS=0V,VGS=±20V			±100	nA	
		VDS=60V,VGS=0V			1	uA	
Zero Gate Voltage Drain Current	Idss	VDS=60V,VGS=0V TJ= 85°C			10		
Drain-Source On-Resistance	RDS(on)	Vgs=10V,Id=0.50A		2.8	5.0	Ω	
		VGS= 5V,ID=0.30A		3.5	5.5		
Source-drain Current	ISD				0.32	A	
Source-drain Current (pulsed)	ISDM (2)				1.4	A	
Forward Transconductance	Gfs(1)	$V_{DS} = 10 V$ , $I_D = 0.5 A$		0.6		S	
Diode Forward Voltage	VsD(1)	$V_{GS} = 0 V, I_{S} = 0.2A$		0.85	1.5	V	
Dynamic							
Total Gate Charge	Qg			1.4	2.0	nC	
Gate-Source Charge	Qgs	$V_{DD} = 30 V, I_D = 1 A, V_{GS} = 5 V$		0.8			
Gate-Drain Charge	Qgd			0.5			
Input Capacitance	Ciss			43		pF	
Output Capacitance	Coss	$V_{DS} = 25 V, f = 1 MHz,$ $V_{GS} = 0$		20			
Reverse Transfer Capacitance	Crss	103 - 0		6		1	
T O T	td(on)			5		- ns	
Turn-On Time	tr	$V_{DD} = 30 V, I_D = 0.5 A$		15			
Terre Off Time	td(off)	$R_G = 4.7\Omega V_{GS} = 4.5 V$		7			
Turn-Off Time	tf			8			

(1) Pulsed: Pulse duration =  $300 \ \mu$ s, duty cycle 1.5 %.

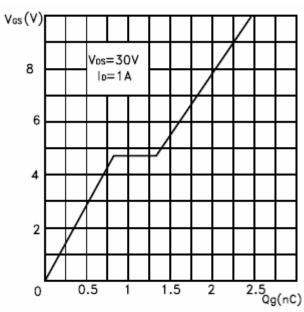
(2) Pulse width limited by safe operating area.

#### TYPICAL CHARACTERISTICS

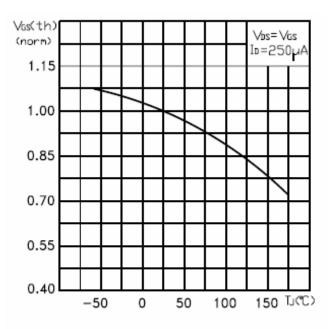


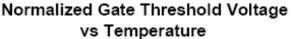
2010/05/25 Ver.2

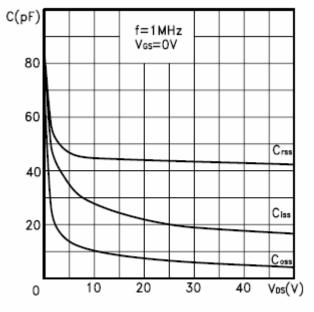
#### TYPICAL CHARACTERISTICS



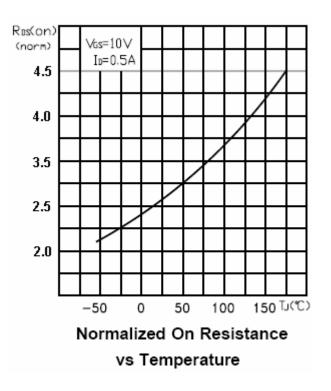
Gate Charge vs Gate-source Voltage





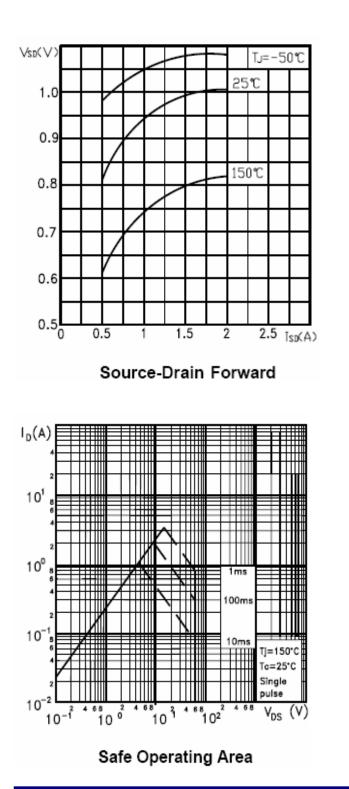


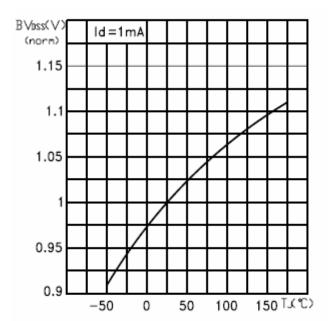
Capacitance Variations



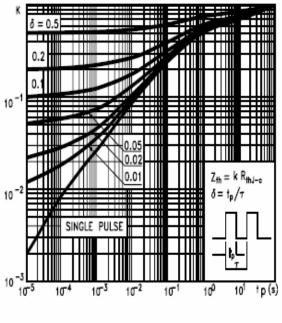
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### TYPICAL CHARACTERISTICS





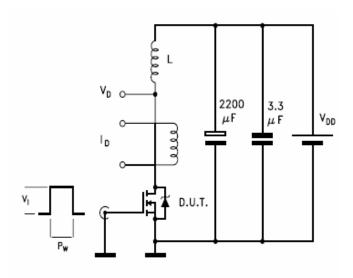
Normalized BVDSS vs Temperature



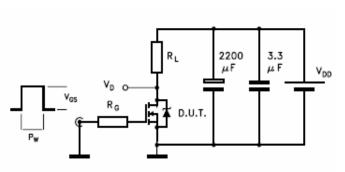
Thermal Impedance

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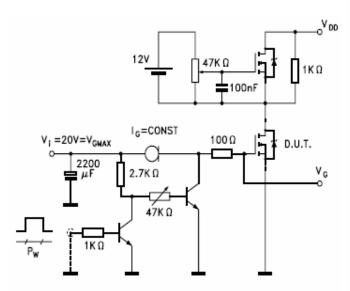
#### TYPICAL TESTING CIRCUIT



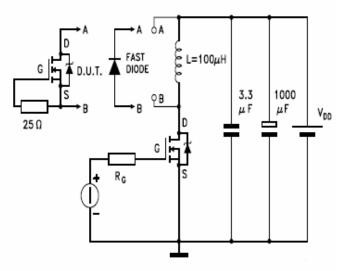
Unclamped Inductive Load Test



Switching Times Test Circuit



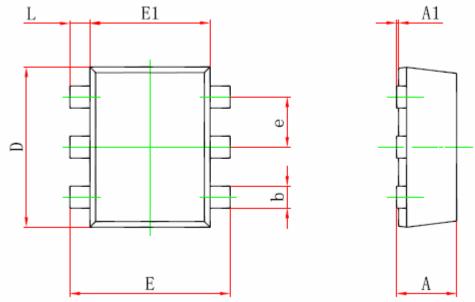
Gate Charge Test Circuit



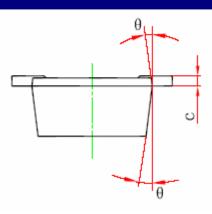
Test Circuit For Inductive Load Switching and Diode Recovery Times



#### SOT-563 PACKAGE OUTLINE







Symbol	Dimensions in Millimeters		Dimensions in Inches		
	Min.	Max.	Min.	Max.	
A	0.525	0.600	0.021	0.024	
A1	0.000	0.050	0.000	0.002	
e	0.450	0.550	0.018	0.022	
с	0.090	0.160	0.004	0.006	
D	1.500	1.700	0.059	0.067	
b	0.170	0.270	0.007	0.011	
E1	1.100	1.300	0.043	0.051	
E	1.500	1.700	0.059	0.067	
L	0.100	0.300	0.004	0.012	
0	7 <sup>0</sup> REF.		7 <sup>0</sup> REF.		



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